COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: PMP8861</th>
<th>REV: C</th>
<th>SUN REV: Not In VersionControl</th>
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<td>Ignore -&gt;</td>
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<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 5/30/2016 2:21:55 PM</td>
<td></td>
<td>TEXAS INSTRUMENTS</td>
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